

Dual N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☒ Surface-mounted package
- ☒ ESD 2KV
- ☒ Low Thermal Resistance

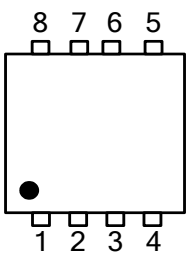
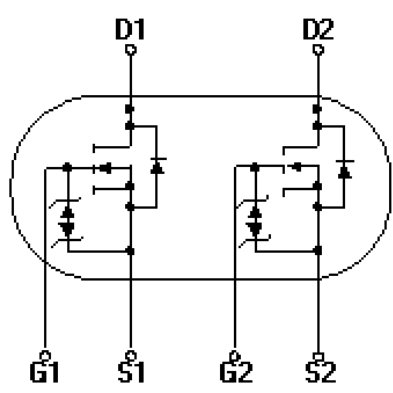
1.2 Applications

- ☒ Motor drivers
- ☒ DC - DC Converter

1.3 Quick reference

- ☒ $BV \leq 30\text{ V}$
- ☒ $P_{tot} \leq 20.8\text{ W}$
- ☒ $I_D \leq 35\text{ A}$
- ☒ $R_{DS(ON)} \leq 13\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ☒ $R_{DS(ON)} \leq 22\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Source(S1)	 Top View PDFN3.3x3.3-8L	
2	Gate(G1)		
3	Source(S2)		
4	Gate(G2)		
5,6	Drain(D2)		
7,8	Drain(D1)		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C = 25\text{ }^{\circ}\text{C}$	30	-	V
V_{GS}	Gate-Source Voltage	$T_C = 25\text{ }^{\circ}\text{C}$	-	± 20	V
I_D^*	Drain Current (DC)	$T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	35	A
		$T_C = 100\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$		19.9	A
$I_{DM}^{*,**,***}$	Drain Current (Pulsed)	$T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	79	A
P_{tot}^*	Total Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	-	20.8	W
T_{stg}	Storage Temperature		- 55	150	$^{\circ}\text{C}$
T_J	Junction Temperature		-	150	$^{\circ}\text{C}$
I_S	Diode Forward Current	$T_C = 25\text{ }^{\circ}\text{C}$	-	35	A
E_{AS}^*	Single Pulsed Avalanche Energy	$V_{DD} = 30\text{ V}, L = 1\text{ mH}$	-	45	mJ
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	62.5	$^{\circ}\text{C} / \text{W}$
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case		-	6	

Notes :

- * Surface Mounted on 1 in² pad area, $t \leq 10\text{ sec}$
- ** Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- *** Limited by bonding wire

4. Marking Information

Product Name	Marking
KJ1503QD	1503D YWWXXX YWWXXX: Date Code

5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
KJ1503QD	PDFN3.3*3.3			5000	

Note: KUAJIJEXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C)

6. Electrical Characteristics (T_A = 25 °C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	30	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _{DS} = 250 μA	1	-	2.5	V
I _{DSS}	Zero Gate Voltage Source Current	V _{DS} = 24 V, V _{GS} = 0 V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{GS} = ± 20 V, V _{DS} = 0 V	-	-	± 10	uA
R _{DS(ON)} ^a	Drain-Source On-State Resistance	V _{GS} = 10 V, I _D = 15 A	-	11.5	13	m Ω
		V _{GS} = 4.5 V, I _D = 10 A	-	19	23	
Diode Characteristics						
V _{SD} ^a	Diode Forward Voltage	I _{SD} = 15 A, V _{GS} = 0 V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _{SD} = 15 A, dI _{SD} /dt = 100 A/μs	-	4.3	-	nS
Q _{rr}	Reverse Recovery Charge		-	0.9	-	nC
Dynamic Characteristics ^b						
C _{iss}	Input Capacitance	V _{GS} = 0 V, V _{DS} = 15 V Frequency = 1 MHz	-	941	-	pF
C _{oss}	Output Capacitance		-	83	-	
C _{rss}	Reverse Transfer Capacitance		-	70	-	
t _{d(on)}	Turn-on Delay Time	V _{DS} = 15 V, V _{GEN} = 10 V, R _G = 3.9 Ω, R _L = 1 Ω, I _D = 15 A	-	5	-	nS
t _r	Turn-on Rise Time		-	43.9	-	
t _{d(off)}	Turn-off Delay Time		-	23.7	-	
t _f	Turn-off Fall Time		-	14.9	-	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{GS} = 10 V, V _{DS} = 15 V, I _{DS} = 15 A	-	17.2	-	nC
Q _{gs}	Gate-Source Charge		-	5	-	
Q _{gd}	Gate-Drain Charge		-	2.57	-	

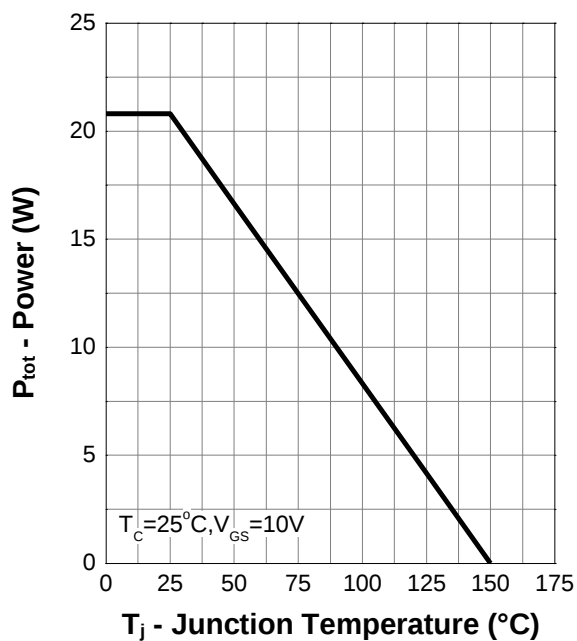
Notes :

a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2 %

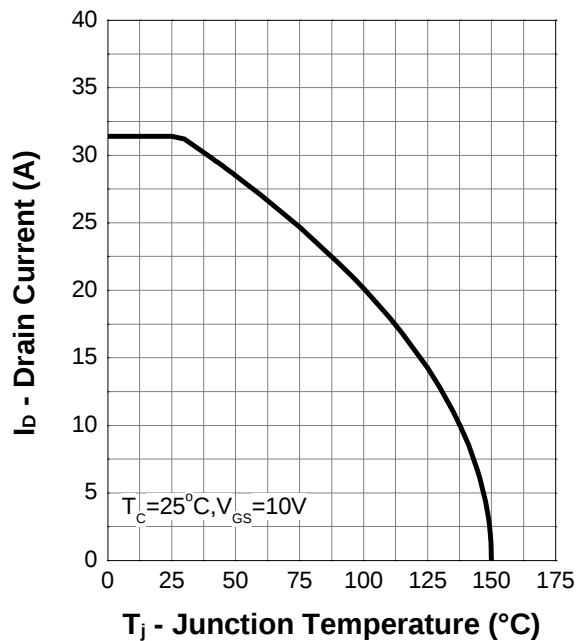
b : Guaranteed by design, not subject to production testing

7. Typical Characteristics (Cont.)

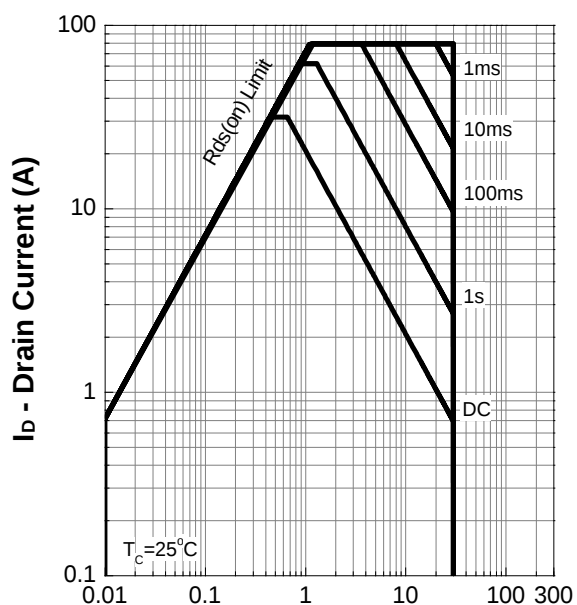
Power Capability



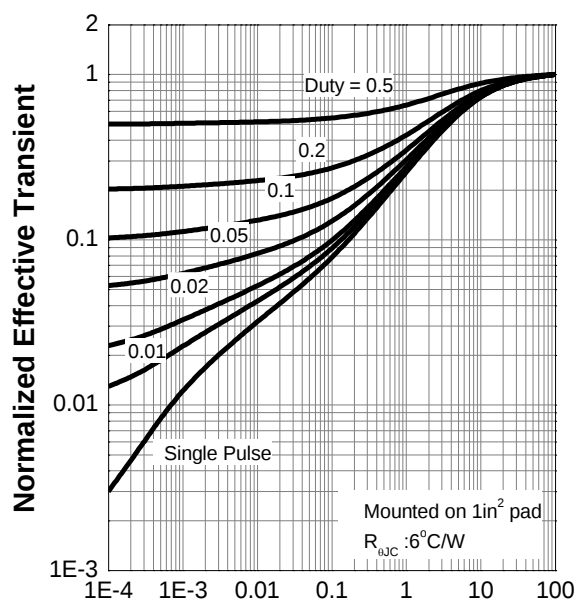
Current Capability



Safe Operation Area



Transient Thermal Impedance

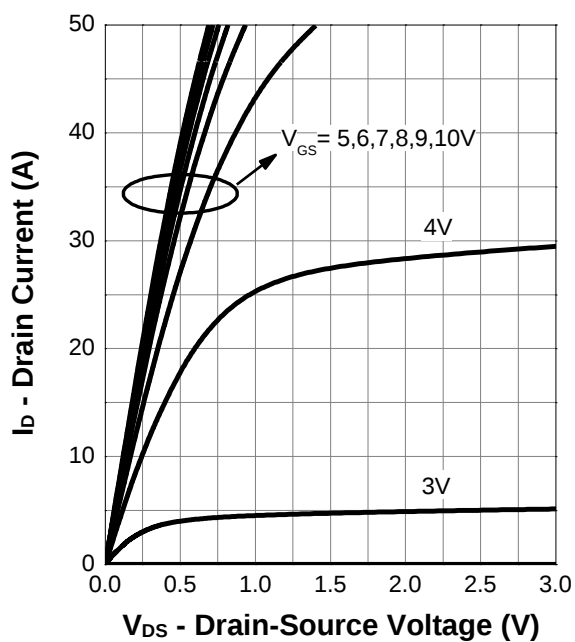


V_{DS} - Drain-Source Voltage (V)

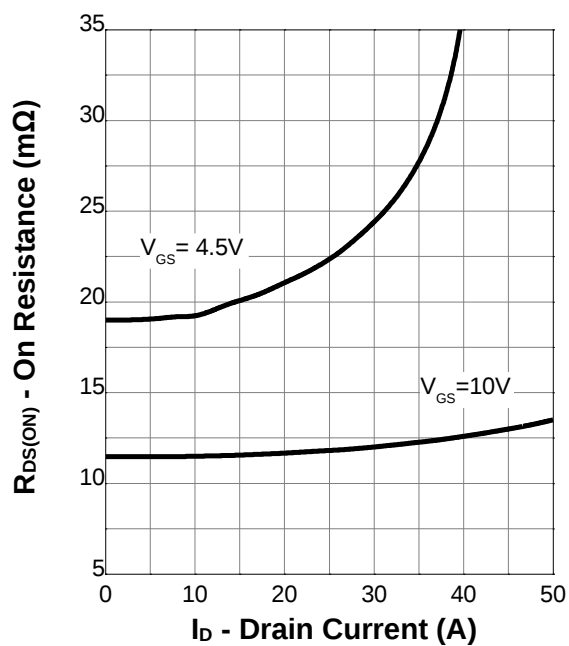
Square Wave Pulse Duration (sec)

7. Typical Characteristics (Cont.)

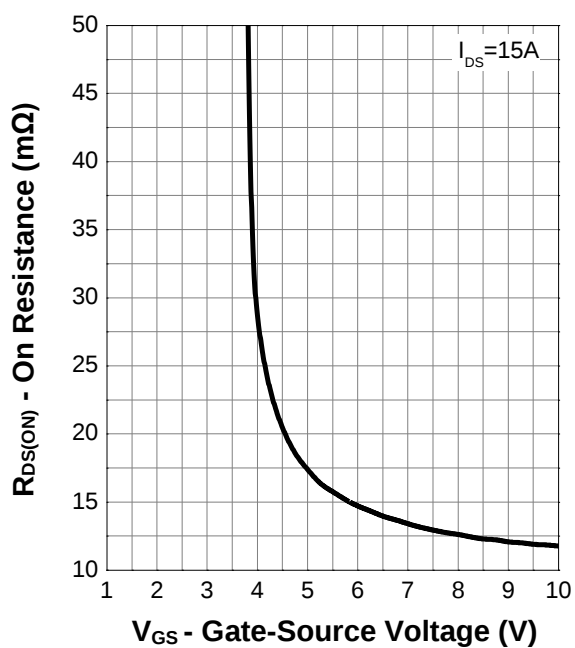
Output Characteristics



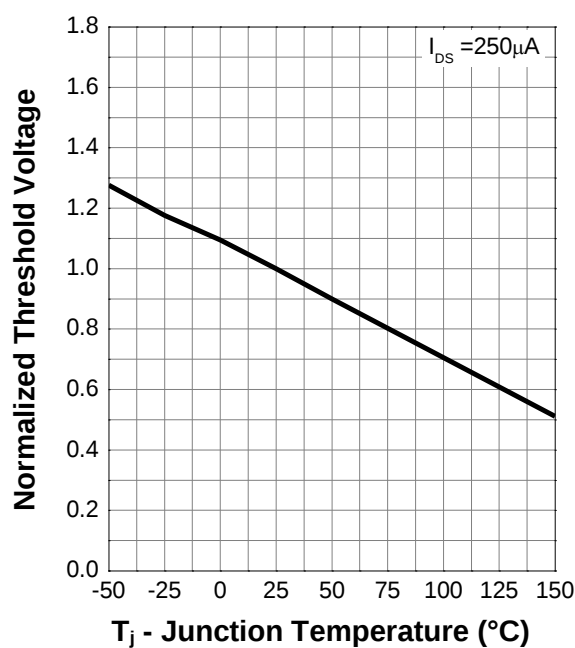
On Resistance



Transfer Characteristics

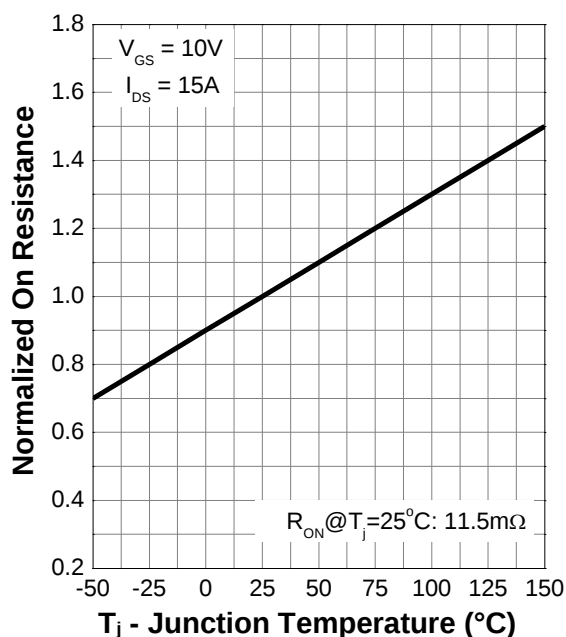


Normalized Threshold Voltage

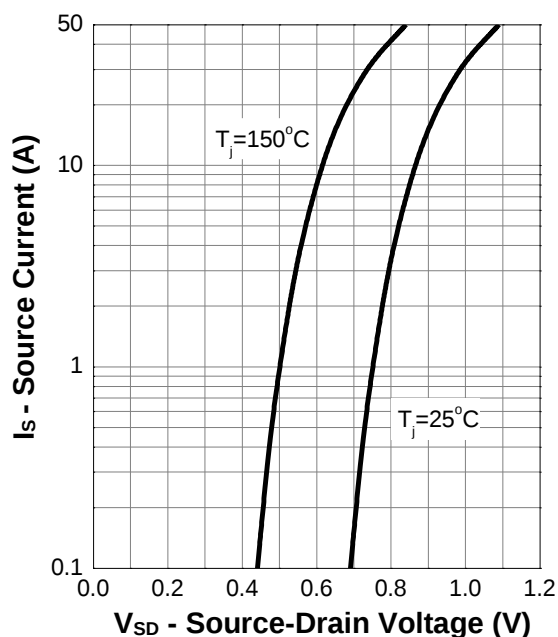


7. Typical Characteristics (Cont.)

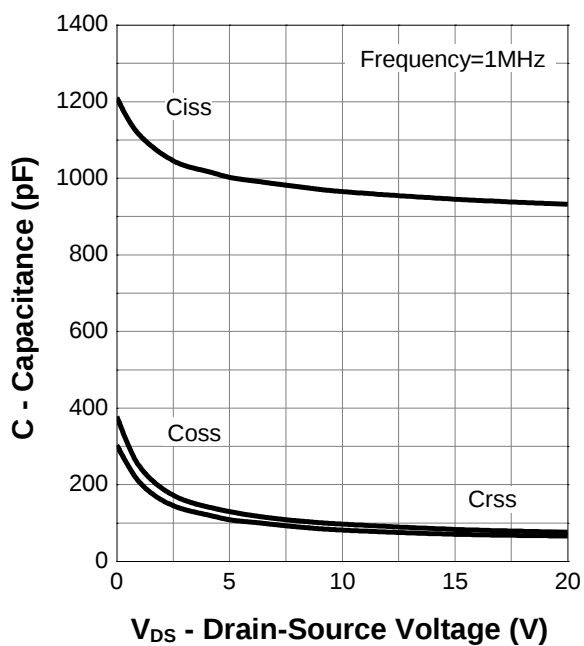
Normalized On Resistance



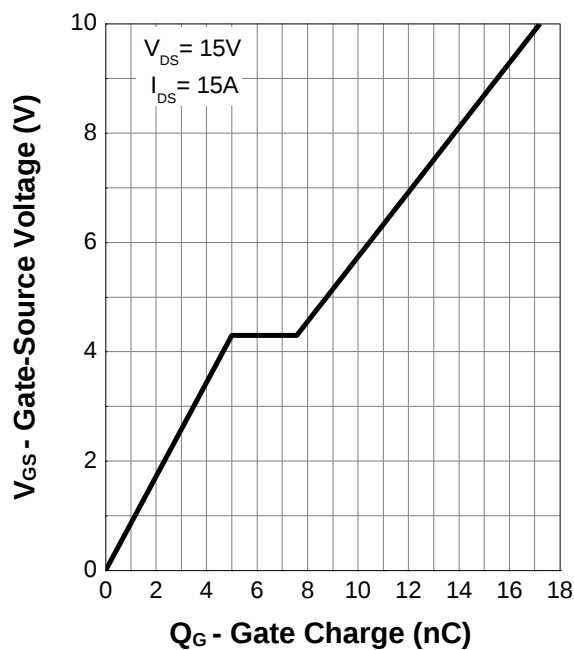
Diode Forward Current



Capacitance

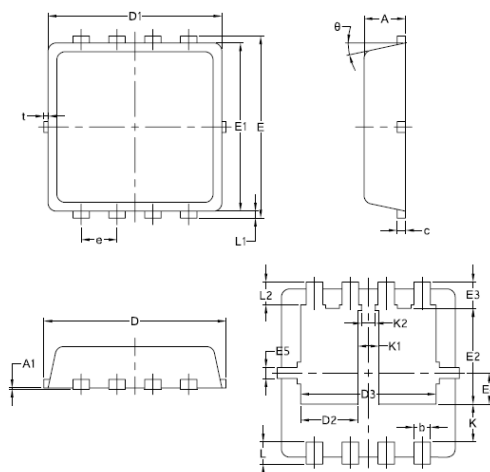


Gate Charge



8. Package Dimensions

PDFN 3.3x3.3-8L (Dual) Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	0.70	0.85
A1	/	0.05
b	0.25	0.39
c	0.14	0.20
D	3.20	3.45
D1	3.05	3.25
D2	0.84	1.24
D3	2.30	2.60
E	3.20	3.40
E1	2.95	3.15
E2	1.60	1.90
E3	0.28	0.65
E4	0.37	0.77
E5	0.10	0.30
e	0.60	0.70
K	0.50	0.80
K1	0.30	0.53
K2	0.15	0.35
L	0.30	0.50
L1	0.06	0.20
L2	0.27	0.57
t	0	0.13
θ	10°	14°